IGBT - Field Stop, Trench

650 V, 75 A

FGH75T65SQD

Description

Using novel field stop IGBT technology, ON Semiconductor's new series of field stop 4th generation IGBTs offer the optimum performance for solar inverter, UPS, Welder, Telecom, ESS and PFC applications where low conduction and switching losses are essential.

Features

- Maximum Junction Temperature : T_J =175°C
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} =1.6 V(Typ.) @ I_C = 75 A
- 100% of the Parts Tested for $I_{LM}(1)$
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- These Devices are Pb-Free and are RoHS Compliant

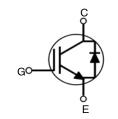
Applications

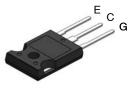
• Solar Inverter, UPS, Welder, Telecom, ESS, PFC



ON Semiconductor®

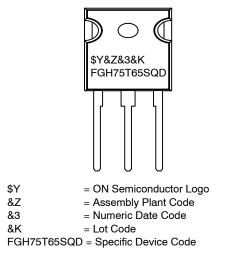
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TO-247-3LD CASE 340CH

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS (T_C = 25° C unless otherwise noted)

Desc	Symbol	Rating	Unit	
Collector to Emitter Voltage	V _{CES}	650	V	
Gate to Emitter Voltage	V _{GES}	±20	V	
Transient Gate to Emitter Voltage	7 F	±30	V	
Collector Current	$T_{\rm C} = 25^{\circ}{\rm C}$	Ι _C	150	А
Collector Current	$T_{\rm C} = 100^{\circ}{\rm C}$	7 F	75	А
Pulsed Collector Current	$T_{\rm C} = 25^{\circ}{\rm C}$	I _{LM} (Note 1) 300		А
Pulsed Collector Current		I _{CM} (Note 2)	300	А
Diode Forward Current	$T_{\rm C} = 25^{\circ}{\rm C}$	١ _F	75	А
Diode Forward Current	$T_{\rm C} = 100^{\circ}{\rm C}$	7 F	50	А
Pulsed Diode Maximum Forward Curre	I _{FM} (Note 2)	1 (Note 2) 300		
Maximum Power Dissipation	$T_{\rm C} = 25^{\circ}{\rm C}$	PD	375	W
Maximum Power Dissipation	$T_{\rm C} = 100^{\circ}{\rm C}$	7 F	188	W
Operating Junction Temperature	TJ	-55 to +175	°C	
Storage Temperature Range	T _{stg}	-55 to +175	°C	
Maximum Lead Temp. for soldering Pu	ΤL	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, I_C = 300 \text{ A}, R_G = 3 \Omega$, Inductive Load 2. Repetive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Parameter	Symbol	FGH75T65SQD-F155	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$ (IGBT)	0.4	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$ (Diode)	0.65	°C/W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH75T65SQD-F155	FGH75T65SQD	TO-247-3 (Pb-Free)	Tube	-	-	30

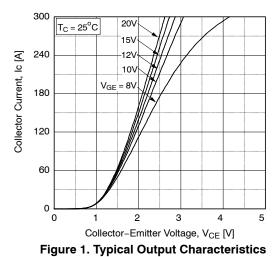
ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
OFF CHARACTERISTICS						
Collector to Emitter Breakdown Voltage	BV _{CES}	$V_{GE} = 0 V, I_{C} = 1 mA$	650	-	-	V
Temperature Coefficient of Breakdown Voltage	$\Delta BV_{CES}/\Delta T_{J}$	I_{C} = 1 mA, Reference to 25°C	-	0.6	_	V/°C
Collector Cut-Off Current	I _{CES}	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μΑ
G-E Leakage Current	I _{GES}	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
ON CHARACTERISTICs						-
G-E Threshold Voltage	V _{GE(th)}	I_{C} = 75 mA, V_{CE} = V_{GE}	2.6	4.5	6.4	V
Collector to Emitter Saturation Voltage	V _{CE(sat)}	I _C = 75 A, V _{GE} = 15 V	-	1.6	2.1	V
		I_{C} = 75 A, V_{GE} = 15 V, T_{C} = 175°C	-	1.92	-	V

ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^{\circ}C$ unless otherwise noted) (continued)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{ies}	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	4845	-	pF
Output Capacitance	C _{oes}		-	155	-	pF
Reverse Transfer Capacitance	C _{res}	7	-	14	-	pF
SWITCHING CHARACTERISTICS	-					-
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 18.8 \text{ A},$	-	23	-	ns
Rise Time	t _r	$R_G = 4.7 \Omega, V_{GE} = 15 V,$ Inductive Load, $T_C = 25^{\circ}C$	-	10	-	ns
Turn-Off Delay Time	t _{d(off)}		-	120	-	ns
Fall Time	t _f	7	-	7	-	ns
Turn-On Switching Loss	E _{on}	-	-	300	-	μJ
Turn-Off Switching Loss	E _{off}		-	70	-	μJ
Total Switching Loss	E _{ts}		-	370	-	μJ
Turn-On Delay Time	t _{d(on)}	V_{CC} = 400 V, I _C = 37.5 A, R _G = 4.7 Ω, V _{GE} = 15 V, Inductive Load, T _C = 25°C	-	26	-	ns
Rise Time	tr		-	19	-	ns
Turn-Off Delay Time	t _{d(off)}		-	114	-	ns
Fall Time	t _f		-	11	-	ns
Turn-On Switching Loss	E _{on}		-	746	-	μJ
Turn-Off Switching Loss	E _{off}		-	181	-	μJ
Total Switching Loss	E _{ts}		-	927	-	μJ
Turn-On Delay Time	t _{d(on)}	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 400 \; V, \; I_C = 18.8 \; A, \\ R_G = 4.7 \; \Omega, \; V_{GE} = 15 \; V, \\ \mbox{Inductive Load}, \; T_C = 175^\circ C \end{array}$	-	22	-	ns
Rise Time	tr		-	12	-	ns
Turn-Off Delay Time	t _{d(off)}		-	135	-	ns
Fall Time	t _f		-	14	-	ns
Turn-On Switching Loss	E _{on}		-	760	-	μJ
Turn-Off Switching Loss	E _{off}		-	180	-	μJ
Total Switching Loss	E _{ts}		-	940	-	μJ
Turn-On Delay Time	t _{d(on)}	$V_{\rm CC} = 400 \text{ V}, I_{\rm C} = 37.5 \text{ A},$	-	24	-	ns
Rise Time	tr	$R_G = 4.7 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 175^{\circ}C$	-	24	-	ns
Turn-Off Delay Time	t _{d(off)}		-	125	-	ns
Fall Time	t _f		-	10	-	ns
Turn-On Switching Loss	E _{on}		-	1520	-	μJ
Turn–Off Switching Loss	E _{off}		_	401	-	μJ
Total Switching Loss	E _{ts}	1	_	1921	-	μJ
Total Gate Charge	Qg	V_{CE} = 400 V, I _C = 75 A, V _{GE} = 15 V	-	128	-	nC
Gate to Emitter Charge	Q _{ge}	1	_	23	-	nC
Gate to Collector Charge	Q _{gc}	1	_	29	-	nC

Parametr	Symbol	Test Conditions		Min	Тур	Max	Unit
Diode Forward Voltage	V _{FM}	I _F = 50 A	$T_{C} = 25^{\circ}C$	-	2.0	2.6	V
			T _C = 175°C	_	1.64	-	
Reverse Recovery Energy	E _{rec}	$I_F = 50 \text{ A}, \text{ dI}_F / \text{ dt} = 200 \text{ A}/\mu\text{s}$	T _C = 175°C	-	61	-	μJ
Diode Reverse Recovery Time	t _{rr}		$T_{C} = 25^{\circ}C$	-	43	-	ns
			T _C = 175°C	-	210	-	
Diode Reverse Recovery Charge	Q _{rr}		$T_C = 25^{\circ}C$	-	90	-	nC
			T _C = 175°C	-	1280	-	





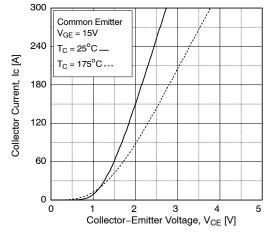


Figure 3. Typical Saturation Voltage Characteristics

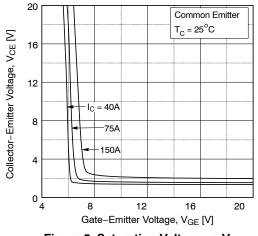
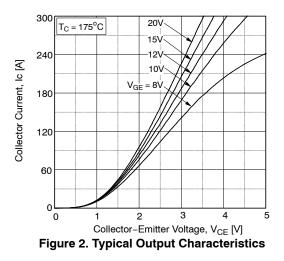


Figure 5. Saturation Voltage vs V_{GE}



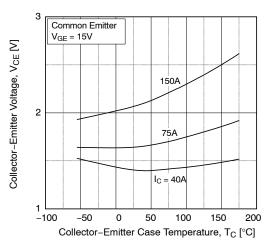


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

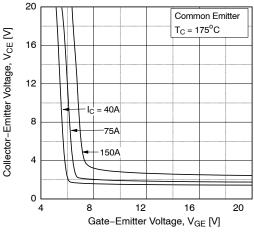


Figure 6. Saturation Voltage vs V_{GE}

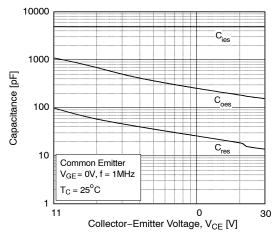


Figure 7. Capacitance Characteristics

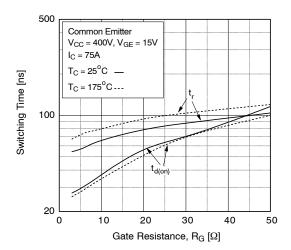
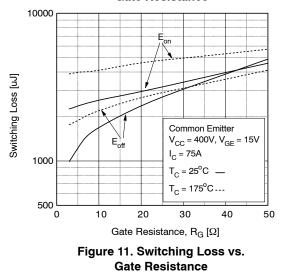


Figure 9. Turn-On Characteristics vs. Gate Resistance



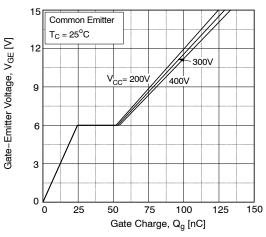


Figure 8. Gate Charge Characteristic

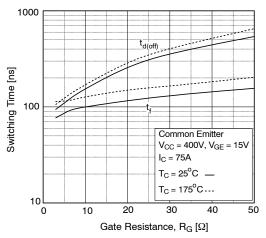
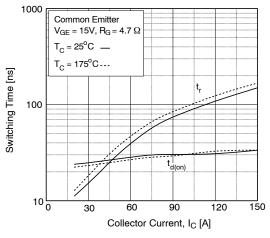
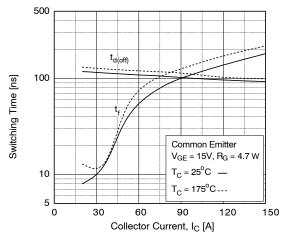


Figure 10. Turn–Off Characteristics vs. Gate Resistance









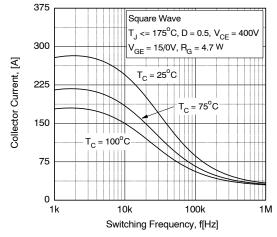


Figure 15. Load Current vs. Frequency

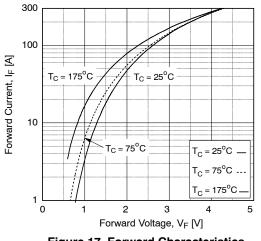


Figure 17. Forward Characteristics

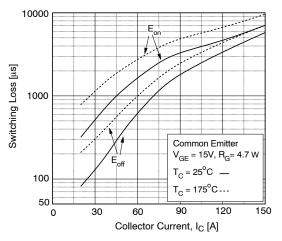


Figure 14. Switching Loss vs. Collector Current

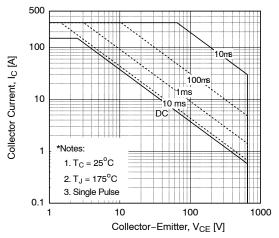


Figure 16. SOA Characteristics

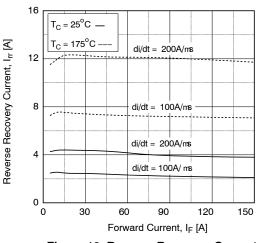
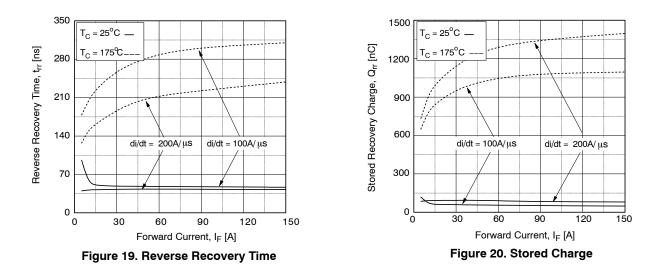
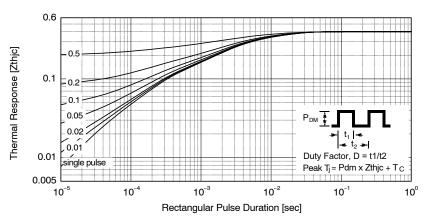
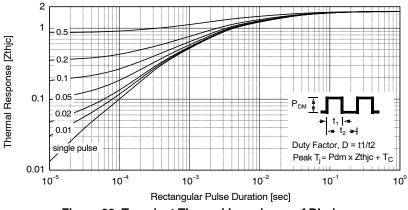


Figure 18. Reverse Recovery Current



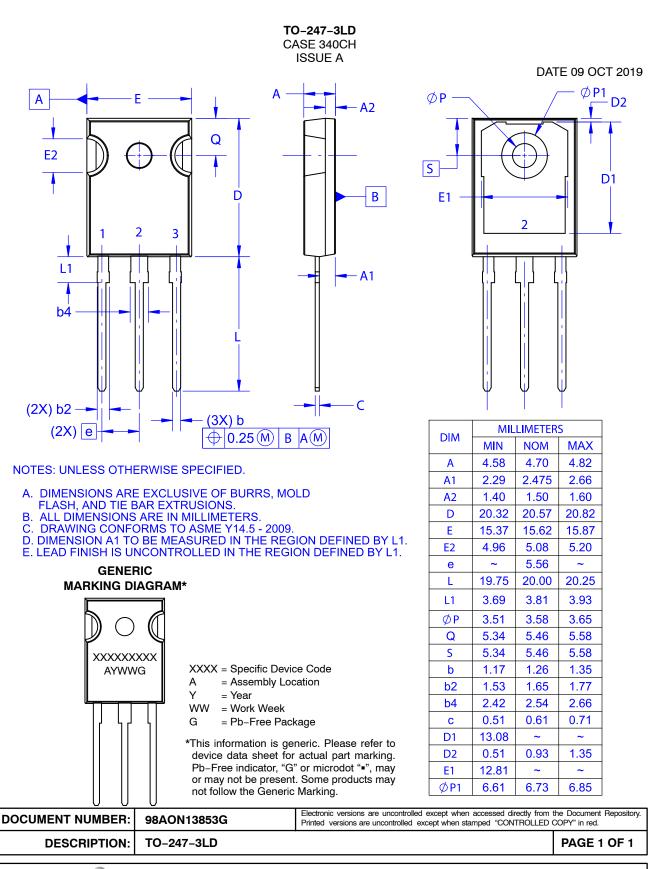












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